## nexperia

## **Quarterly Reliability Monitoring Results**

Quarters: Q1/2022 to Q4/2023 Based on structural similarity

| Supplier   |                             | User Part Number  |             |           |            |           |
|--|-----------------------------|---|-------------|-----------|------------|-----------|
| Nexperia B.V.<br>Name of Laboratory<br>Assembly reliability labs<br>Based on AEC-Q101 Test |                             | BZX585-C68 Part Description                             |             |           |            |           |
|  |                             |   |             |           |            |           |
|  |                             | SMD package   |             |           |            |           |
|  |                             | Test Conditions   | Duration    | # Lots    | # Quantity | # Rejects |
|  |                             |   | TEST        |           |            |           |
|  | Pre- and Post-Stress        |   |             |           |            |           |
| # E1   | Electrical Test             | Tamb = 25 °C  | N/A         | see below | all parts  | see below |
|  |                             | JESD22-A113   |             |           |            |           |
|  |                             | Bake Tamb = 125 °C                                      | 24 hours    |           |            |           |
|  | PC                          | Soak Tamb = 85 °C, RH = 85%                             | 168 hours   |           |            |           |
| # A1   | Preconditioning             | Reflow soldering  | 3 cycles    | 1514      | 64430      | 0         |
|  |                             | MIL-STD-750-1   |             |           |            |           |
|  | HTRB                        | M1038 Method A  |             |           |            |           |
|  |                             | Tj = Tjmax, VR = 80 % of rated reverse                  | 10001       | 250       |            |           |
| # B1   | Bias                        | voltage   | 1000 hours  | 250       | 11400      | 0         |
|  |                             | MIL-STD-750-1   |             |           |            |           |
|  | SSOP                        | M1038 Method B  |             |           |            |           |
| # B1b  | Steady State Operational    | Tj = Tjmax, Iz = 100% of max. datasheet reverse current | 1000 haven  | 4.4       | 1920       | 0         |
| # DID  | Steady State Operational    |   | 1000 hours  | 44        | 1920       | 0         |
|  | тс                          | JESD22-A104   |             |           |            |           |
| # A4   | Temperature Cycling         | -65 °C to Tjmax, not to exceed 150°C                    | 1000 cycles | 311       | 14080      | 0         |
| # 44   | Temperature cycing          |   | 1000 Cycles | 511       | 14000      | 0         |
|  | UHAST                       | JESD22-A118   |             |           |            |           |
| # A3 <b>or</b>   | Unbiased HAST               | Tamb = 130 °C, RH = 85 %                                | 96 hours    | 311       | 14080      | 0         |
|  |                             | JESD22-A102   |             |           |            |           |
|  | AC                          | Tamb = $121 ^{\circ}$ C, RH = $100 ^{\circ}$            |             |           |            |           |
| # A3 alt   | Autoclave                   | Pressure = $205 \text{ kPa} (29.7 \text{ psia})$        |             |           |            |           |
|  |                             |   |             |           |            |           |
|  | H3TRB                       | JESD22-A101   |             |           |            |           |
|  | High Humidity High          | Tamb = 85 °C, RH = 85%, VR = 80 % of                    |             |           |            |           |
| # A2 alt   | Temperature Reverse Bias    | rated reverse voltage <sup>[1]</sup>                    | 1000 hours  | 311       | 14080      | 0         |
|  |                             | MIL-STD-750 Method 1037                                 |             |           |            |           |
|  | IOL                         | ton = toff, devices powered to insure $\Delta T_j$ =    |             |           |            |           |
| # A5   | Intermittent Operating Life | · · · · ·   | 1000 hours  | 312       | 14120      | 0         |
|  |                             |   |             |           |            |           |
|  | RSH                         | JESD22-A111   |             |           |            |           |
| # C8   | Resistance to Solder Heat   | 260 °C ± 5 °C   | 10 s        | 269       | 8070       | 0         |
|  | SD                          |   |             |           |            |           |
| # C10  | Solderability               | J-STD-002   |             | 19        | 6660       | 0         |

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

## Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| 2,68E+09 |
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